

Indianapolis, IN, USA - September 2019

Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Fri	Credit
A, Shaziah	General Motors Company	General Motors Company	1	1				2
Abbott, John	Corning Incorporated	Corning Incorporated	1	1	1	1		4
Abramson, David	Texas Instruments Incorporated	Texas Instruments Incorporated			1	1		2
Anslow, Peter	Ciena	Ciena	1	1	1	1		4
Araki, Nobuyasu	Yazaki Corporation	YAZAKI	1	1	1	1		4
Baggett, Tim	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1			3
Baldwin, Thananya	Keysight Technologies	Keysight Technologies	1	1	1	1		4
Baumgartner, Steven	Avera Semiconductor	Avera Semiconductor			1	1		2
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.			1	1		2
Bernstein, Gary	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1				2
Beruto, Piergiorgio	Canova Tech S.r.l.	Canova Tech Srl	1	1	1			3
Bhatt, Vipul	Finisar Corporation	Finisar Corporation	1	1	1	1		4
bordogna, mark		Intel				1		1
Boyer, Rich	Aptiv - Signal and Power Solutions	Aptiv Signal and Power Solutions	1	1	1	1		4
Brandt, David	Rockwell Automation	Rockwell Automation	1	1		1		3
Braun, Ralf-Peter	Deutsche Telekom AG	Deutsche Telekom AG	1	1	1	1		4
Brillhart, Theodore	Fluke Corporation	Fluke Corporation	1	1	1	1		4
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions	1	1	1	1		4
Brown, Blake		University of New Hampshire InterO	1	1	1	1		4
Bruckman, Leon	HUAWEI	HUAWEI	1	1	1	1		4
Butter, Adrian	Avera Semiconductor	Avera Semiconductor	1	1	1	1		4
Carlson, Steven	High-Speed Design Inc.	Robert Bosch GmbH	1	1	1	1		4
Chalupsky, David	Intel Corporation	Intel Corporation		1	1	1		3
Chang, Xin	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Chang, Yongmao	Inphi Corporation	Source Photonics	1	1	1			3
Chen, Chan	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.	1	1	1	1		4
Choi, Eunmin	Daegu Gyeongbuk Institute of Scienc	Daegu Gyeongbuk Institute of Scienc	1	1	1	1		4
Choudhury, Golam	OFS	OFS	1	1	1	1		4
Coffey, Joseph		CommScope	1	1	1			3
Cole, Christopher R	Finisar Corporation	Finisar Corporation	1					1
D'Ambrosia, John	Futurewei Technologies	Futurewei (U.S. Subsidiary of Huawei	1	1	1	1		4

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Darshan, Yair	Microchip Technology, Inc.	Microsemi Corporation	1	1		1		3
Dawe, Piers J G	Mellanox Technologies	Mellanox Technologies	1	1	1	1		4
Dawson, Fred	Chemours Canada Company	Chemours Canada Company		1	1	1		3
Deandrea, John	Finisar Corporation	Finisar Corporation		1	1			2
DeSanti, Claudio	Google	Google		1	1	1		3
DiBiaso, Eric	TE Connectivity	TE Connectivity		1	1	1		3
Diminico, Christopher	M C Communications, LLC	Panduit Corp.	1	1	1	1		4
Donahue, Curtis	University of New Hampshire InterO	UNH-IOL	1	1	1	1		4
Du, Liang	Google	Google			1			1
Dudek, Michael	Marvell	Marvell	1	1	1	1		4
Effenberger, Frank	Huawei Technologies Co. Ltd	Futurewei Technologies	1	1	1			3
Estes, David	Spirent Communications	Spirent Communications	1	1	1	1		4
Ewen, John	Avera Semiconductor	Avera Semiconductor			1	1		2
Ferretti, Vincent	Corning Incorporated	Corning Incorporated	1	1	1	1		4
Franchuk, Brian	Emerson Automation Solutions	Emerson Automation Solutions	1		1	1		3
Fritsche, Matthias	HARTING Technologie Gruppe	HARTING Electronics GmbH	1	1	1	1		4
Frosch, Richard	Phihong USA Inc,	Phihong USA Inc,		1		1		2
Gardner, Mike	Molex Incorporated	Molex Incorporated	1	1	1	1		4
Gauthier, Claude	NXP Semiconductors	NXP Semiconductors	1	1	1	1		4
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Inphi	1	1	1	1		4
Gilb, James	General Atomics Aeronautical System	GA-ASI, USD, Gilb Consulting	1	1	1	1		4
Goergen, Joel	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Gore, Brandon	Samtec, Inc.	Samtec, Inc.			1	1		2
Gorshe, Steven Scott	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1	1		4
Graber, Steffen	Pepperl+Fuchs AG	Pepperl+Fuchs AG	1	1	1	1		4
Grow, Robert	RMG Consulting	RMG Consulting	1	1	1	1		4
Gubow, Martin	Keysight Technologies	Keysight Technologies	1	1	1	1		4
Gustlin, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.			1	1		2
Hajduczenia, Marek	Charter Communications	Charter Communications	1	1	1	1		4
He, Xiang	HUAWEI	HUAWEI	1	1	1	1		4
Healey, Adam	Broadcom Inc.	Broadcom Inc.	1	1	1	1		4

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Heck, Howard	Intel Corporation	Intel Corporation		1	1	1		3
Hegde, Rajmohan	Broadcom Corporation	Broadcom Ltd.			1	1		2
Holden, Brian	Kandou Bus	Kandou Bus		1	1	1		3
Horner, Rita	Synopsys, Inc.	Synopsys, Inc.	1	1	1			3
HYAKUTAKE, YASUHIRO	Adamant Namiki Precision Jewel Co.	Adamant Namiki Precision Jewel Co.	1	1	1	1		4
Ingham, Jonathan	Foxconn Interconnect Technology	Foxconn Interconnect Technology	1	1	1	1		4
Isono, Hideki	FUJITSU	Fujitsu Optical Components Limited	1	1	1	1		4
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co. Ltd	1	1	1	1		4
Ito, Hiroaki	Yazaki Corporation	Yazaki Corporation	1		1	1		3
Jackson, Kenneth	Sumitomo Electric Device Innovation	Sumitomo Electric Industries, LTD	1	1	1	1		4
Johnson, John	Broadcom Limited	Broadcom Limited	1	1	1			3
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Jones, Peter	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1			3
Kadry, Haysam	Ford Motor Company	Ford Motor Company	1	1	1	1		4
Kang, Su Won	GCT Semiconductor, Inc.	Velonect		1	1	1		3
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Kasapi, Athanasios	Cadence Design Systems, Inc.	Cadence Design Systems, Inc.			1	1		2
Kim, Andrew	Spectra7 Microsystems	Spectra7 Microsystems			1	1		2
Kim, Inho	Marvell	Marvell	1	1	1	1		4
Kimber, Eric	Semtech Ltd	Semtech Ltd	1	1	1	1		4
Kinningham, Alan	I-Pex	I-Pex			1			1
Knittle, Curtis	Cable Television Laboratories Inc. (Ca	Cable Television Laboratories Inc. (Ca		1	1	1		3
Kocsis, Sam	Amphenol Corporation	Amphenol Corporation			1	1		2
Kolesar, Paul	CME Consulting	CommScope, Inc.	1	1	1	1		4
Kondo, Taiji	MegaChips Corporation	MegaChips Corporation	1	1	1	1		4
Kramer, Glen	Broadcom Corporation	Broadcom Corporation		1	1	1		3
Laubach, Mark	Broadcom Corporation	Broadcom Corporation	1	1	1	1		4
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1		4
Le Cheminant, Greg	Keysight Technologies	Keysight Technologies	1	1	1	1		4
Lee, Sylvanus	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1		1		3
Levin, Alex	Microsoft Corporation	Microsoft Corporation			1	1		2

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Lewis, David	Lumentum Inc.	Lumentum Inc.	1	1	1	1		4
Lewis, Jon	Dell EMC	Dell EMC	1	1	1	1		4
Li, Mike-Peng	Intel Corporation	Intel Corporation			1	1		2
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.			1	1		2
Lingle, Robert	OFS	OFS	1	1	1			3
Liu, Hai-Feng	Intel	Intel Corporation	1	1	1			3
Liu, Karen	Lightwave Logic	Lightwave Logic	1	1	1			3
Lo, William	Marvell Semiconductor, Inc.	Axonne Inc.		1	1	1		3
Luo, Yuanqiu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1			3
Lusted, Kent	Intel Corporation	Intel Corporation		1	1	1		3
Lyubomirsky, Ilya	Inphi Corporation	Inphi Corporation			1	1		2
Maguire, Valerie	The Siemon Company	The Siemon Company	1	1	1	1		4
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1		4
Malicoat, David	Malicoat Networking Solutions	Malicoat Networking Solutions; SENK	1	1	1	1		4
Maniloff, Eric	Ciena Corporation	Ciena Corporation	1	1	1	1		4
Marris, Arthur	Cadence Design Systems, Inc.	Cadence Design Systems, Inc.	1	1	1	1		4
Mcclellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.		1	1	1		3
McIntosh, James	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1	1		4
McMillan, Larry	Western Digital Corporation	Western Digital Corporation	1	1	1	1		4
McSorley, Gregory	Amphenol Corporation	Amphenol Corporation	1		1	1		3
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.			1	1		2
Mueller, Harald	Endress + Hauser	Endress + Hauser	1	1	1	1		4
Muller, Shimon	Axalume, Inc.	Axalume, Inc.	1	1				2
Murty, Ramana	Broadcom Corporation	Broadcom Corporation	1					1
Nadolny, James	Samtec, Inc.	Samtec		1	1	1		3
Nering, Raymond		Cisco Systems, Inc.		1	1			2
Neveux, Paul	Superior Essex	Superior Essex	1	1	1	1		4
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Nicholl, Shawn	Xilinx	Xilinx	1	1	1	1		4
Nordin, Ronald	Panduit Corp.	Panduit Corp.	1	1				2
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4

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Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1		4
Palkert, Thomas	EIC	Molex-Macom	1		1	1		3
Pardo, Carlos	Knowledge Development for POF SL	KDPOF	1	1	1			3
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation	1	1	1			3
Patel, Harsh	Molex LLC	Molex LLC		1	1	1		3
Pelletier, Erick	TeraXion	TeraXion		1				1
Pepper, Gerald	Keysight Technologies	Keysight Technologies	1	1	1	1		4
Perez De Aranda Alonso, Ruben	Knowledge Development for POF SL	KDPOF	1	1	1	1		4
Pham, Phong	US Conec, Ltd.	US Conec, Ltd.	1	1	1	1		4
Piehler, David	Dell	Dell EMC	1	1	1			3
Pittala, Fabio	Huawei Technologies Duesseldorf Gr	Huawei Technologies Duesseldorf Gr	1	1	1	1		4
Pohl, Christopher	Beckhoff Automation	Beckhoff Automation	1	1	1			3
Powell, William	Nokia	Nokia	1	1	1	1		4
Pozzebon, Dino	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1	1		4
Rabinovich, Rick	Keysight Technologies	Keysight Technologies			1	1		2
Radhamohan, Rajeshmohan	MAXLINEAR INC	MaxLinear Inc	1	1	1	1		4
Rakanovic, Demir	u-blox	u-blox	1	1	1	1		4
Renteria, Victor	Bel Fuse	Bel Fuse	1	1	1	1		4
Salehi, Hamid	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1			3
Sambasivan, Sam	AT&T	AT&T	1	1	1			3
Sayre, Edward	Samtec, Inc.	Teraspeed, a division of Samtec		1	1	1		3
Schmitt, Matthew	Cable Television Laboratories Inc. (Ca	Cable Television Laboratories Inc. (Ca		1	1			2
Sedarat, Hossein	Ethernovia	Ethernovia		1	1	1		3
Sedio, Stephen	TDK Corporation	TDK Corporation	1	1	1	1		4
Sekel, Steve	Keysight Technologies	Keysight Technologies		1	1	1		3
Shariff, Masood	CommScope, Inc.	CommScope, Inc.	1	1	1	1		4
She, Qingya	Fujitsu Network Communications	Fujitsu Network Communications	1	1	1	1		4
Shigematsu, Masayuki	Innovation Core SEI	Innovation Core SEI	1	1	1			3
Shiino, Masato	FURUKAWA ELECTRIC	FURUKAWA ELECTRIC	1	1	1	1		4
Shrikhande, Kapil	Innovium Inc.	Innovium			1	1		2
Shuai, Jialong	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4

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Slavick, Jeff	Broadcom Inc	Broadcom		1	1	1		3
Sluyski, Michael	Acacia Communications	Acacia Communications		1				1
Sommers, Scott	Molex Incorporated	Molex Incorporated	1	1	1	1		4
Sorbara, Massimo	Ikanos Communications, Inc.	GLOBALFOUNDIRES	1	1	1	1		4
Souvignier, Tom	Broadcom Corporation	Broadcom Corporation		1	1	1		3
Sparrowhawk, Bryan	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1	1	1		4
Sprague, Edward	Infinera Corporation	Infinera Corporation		1	1	1		3
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Stewart, Heath	Analog Devices Inc.	Analog Devices Inc.	1	1	1	1		4
Stone, Robert	Broadcom Corporation	Broadcom Corporation			1	1		2
Sun, Junqing	Credo Semiconductor	Credo Semiconductor			1	1		2
Swanson, Steven	Corning Incorporated	Corning Incorporated	1	1	1	1		4
Tailor, Bharat	Semtech Canada Corporation	Semtech Canada Corporation		1	1	1		3
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	FUJITSU LIMITED	1	1	1	1		4
Takahashi, Satoshi	Self Employed	Self Employed	1	1	1	1		4
Takahashi, Tadashi	Nitto Denko Corporation	Nitto Denko Corporation	1	1				2
Takayama, Kazuya	Nitto Denko Corporation	Nitto Denko Corporation	1	1	1	1		4
TAKEUCHI, JUNICHI	JAE Electronics, Inc	JAE Electronics, Inc.		1	1	1		3
Terada, Masaru	OFS	OFS	1	1	1	1		4
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT	1	1	1	1		4
Tracy, Nathan	TE Connectivity	TE Connectivity		1	1	1		3
Tran, Viet	Keysight Technologies	Keysight Technologies			1	1		2
Tremblay, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1		4
Trowbridge, Stephen	Nokia	Nokia	1	1	1	1		4
Tse, Richard	Microchip Technology, Inc.	Microchip Technology, Inc.				1		1
Tu, Mike	Broadcom Corporation	Broadcom Corporation		1	1			2
Twombly, Jeff	Credo Semiconductor	Credo Semiconductor			1	1		2
Ulrichs, Ed	Source Photonics	Source Photonics	1	1	1	1		4
Vanderlaan, Paul	UL LLC	UL LLC	1		1	1		3
Voss, Robert	Panduit Corp.	Panduit Corp.	1	1	1	1		4
Wang, Roy	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1		4

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Welch, Brian	Luxtera	Luxtera	1	1	1	1		4
Wienckowski, Natalie	General Motors Company	General Motors Company	1	1	1	1		4
Wu, Dance	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.		1	1	1		3
Wu, Mau-Lin	MediaTek Inc.	MediaTek Inc.	1	1	1	1		4
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.		1	1	1		3
Wucher, Markus	Endress + Hauser Flowtec AG	Endress + Hauser	1	1	1	1		4
Xu, Yu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1		1	1		3
Yamamoto, Shuto	Nippon Telegraph and Telephone Co	Nippon Telegraph and Telephone Co	1	1	1	1		4
Young, James	CommScope, Inc.	CommScope	1	1	1	1		4
Yseboodt, Lennart	Signify	Signify	1	1	1	1		4
Zhang, Xingxin	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd	1	1	1	1		4
Zhu, Chunhui	Huawei Technologies Co. Ltd	Futurewei Technologies	1	1	1	1		4
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Zimmerman, George	CME Consulting	CME Consulting/ADI, APL Group, Aquantia, BMW, CommScope, Inc., Cisco Systems, and SenTekse	1	1	1	1		4
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.	1	1	1	1		4